



501.36931CX1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#51B  
9/26/02  
Sunter

Applicants: IWASAKI, et al

Serial No.: 09/985,904

Filed: November 6, 2001

For: SEMICONDUCTOR DEVICE HAVING LAYERED  
INTERCONNECT STRUCTURE WITH A COPPER OR PLATINUM  
CONDUCTING FILM AND A NEIGHBORING FILM (As Amended)

Group Art Unit: 2813

Examiner: Stephen W. Smoot

AMENDMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

September 20, 2001

Sir:

In response to the Office Action mailed March 20, 2002, please amend the  
above-identified application as follows:

IN THE SPECIFICATION

Please delete the paragraph from page 22, line 1 to page 24, line 5, and  
substitute therefor the following new paragraph:

β<sup>1</sup> In the third embodiment, at least one of the conductor film 117 as coated with  
the neighboring films 116a, 116b, and the conductor film 123 as coated with the  
neighboring films 122a, 122b shall be formed of a combination of materials that satisfies  
an inequality of  $\{A + B \times (a_p/b_p)\} < 13$ , where A indicates the difference between the  
short side,  $a_n$ , of the rectangular unit cells that constitute the plane with minimum free

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